

# IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Priority Application Serial No. .... 09/392,073  
Priority Filing Date .... September 8, 1999  
Inventor .... Rickie C. Lake, et al  
Assignee .... Micron Technology, Inc.  
Priority Group Art Unit .... 1751  
Priority Examiner .... D. Hamlin  
Attorney's Docket No. .... MI40-327  
Title: An Epoxy, Epoxy System, and Method of Forming a Conductive Adhesive  
Connection

Assistant Commissioner for Patents  
Washington, D. C. 20231  
Attention: Official Draftsman

## LETTER SUBMITTING FORMAL DRAWINGS

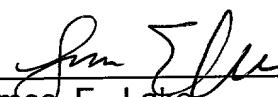
Please enter the enclosed formal drawings in the above-referenced application in place of the originally filed drawings.

Acknowledgment of receipt of the formal drawing sheets and their acceptance into the file is requested.

Respectfully submitted,

Date: 26 Apr 2001

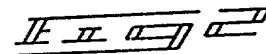
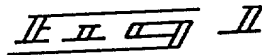
By:

  
James E. Lake  
Reg. No.: 44,854

Enclosures: Two (2) sheets of formal drawings (fig. 1-3)

**EL 465782735**

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